## IGBT - Field Stop, Trench 650 V, 40 A

## FGH40T65SHDF

## Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop $3^{\text {rd }}$ generation IGBTs offer superior conduction and switching performance and easy parallel operation. This device is well suited for the resonant or soft switching application such as induction heating and MWO.

## Features

- Maximum Junction Temperature: $\mathrm{T}_{\mathrm{J}}=175^{\circ} \mathrm{C}$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $\mathrm{V}_{\mathrm{CE}(\mathrm{sat})}=1.45 \mathrm{~V}(\mathrm{Typ}). @ \mathrm{I}_{\mathrm{C}}=40 \mathrm{~A}$
- $100 \%$ of the Parts Tested for $\mathrm{I}_{\mathrm{LM}}$ (Note 1)
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- This Device is $\mathrm{Pb}-$ Free and is RoHS Compliant


## Applications

- Induction Heating, MWO

ON Semiconductor ${ }^{\circledR}$
www.onsemi.com


TO-247-3LD CASE 340CH

MARKING DIAGRAM



ORDERING INFORMATION
See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

| Description | Symbol | FGH40T65SHDF-F155 | Unit |
| :---: | :---: | :---: | :---: |
| Collector to Emitter Voltage | $\mathrm{V}_{\text {CES }}$ | 650 | V |
| Gate to Emitter Voltage | $V_{G E S}$ | $\pm 20$ | V |
| Transient Gate to Emitter Voltage |  | $\pm 30$ | V |
| Collector Current $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $I_{C}$ | 80 | A |
| Collector Current $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ |  | 40 | A |
| Pulsed Collector Current (Note 1) $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | ILM | 120 | A |
| Pulsed Collector Current (Note 2) | $\mathrm{I}_{\text {cm }}$ | 120 | A |
| Diode Forward Current $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{F}}$ | 40 | A |
| Diode Forward Current $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ |  | 20 | A |
| Pulsed Diode Maximum Forward Current | $\mathrm{I}_{\text {FM }}$ | 60 | A |
| Maximum Power Dissipation $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 268 | W |
| Maximum Power Dissipation $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ |  | 134 | W |
| Operating Junction Temperature | $\mathrm{T}_{J}$ | -55 to +175 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -55 to +175 | ${ }^{\circ} \mathrm{C}$ |
| Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds | $\mathrm{T}_{\mathrm{L}}$ | 300 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. $\mathrm{V}_{\mathrm{CC}}=400 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=120 \mathrm{~A}, \mathrm{R}_{\mathrm{G}}=30 \Omega$, Inductive Load
2. Repetitive Rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

| Parameter | Symbol | FGH40T65SHDF-F155 | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance, Junction to Case (IGBT) | $\mathrm{R}_{\theta \mathrm{\theta C}}$ | 0.56 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance, Junction to Case (Diode) | $\mathrm{R}_{\theta \mathrm{\theta C}}$ | 1.75 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance, Junction to Ambient | $\mathrm{R}_{\theta \mathrm{\theta A}}$ | 40 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## PACKAGE MARKING AND ORDERING INFORMATION

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
| :---: | :---: | :---: | :---: | :---: | :---: |
| FGH40T65SHDF | FGH40T65SHDF-F155 | TO-247-3LD | - | - | 30 |

ELECTRICAL CHARACTERISTICS OF THE IGBT ( $T_{C}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |


| OFF CHARACTERISTICS |  |  |  |  |  |
| :--- | :---: | :--- | :---: | :---: | :---: |
| Collector to Emitter Breakdown Voltage | $\mathrm{BV}_{\mathrm{CES}}$ | $\mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$ | 650 | - | - |
| Temperature Coefficient of Breakdown <br> Voltage | $\Delta \mathrm{BV}_{\mathrm{CES}} / \Delta \mathrm{T}_{\mathrm{J}}$ | $\mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$ |  | 0.6 |  |
| Collector Cut-Off Current | $\mathrm{I}_{\mathrm{CES}}$ | $\mathrm{V}_{\mathrm{CE}}=\mathrm{V}_{\mathrm{CES}}, \mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V}$ | - | - | 250 |
| G-E Leakage Current | $\mathrm{I}_{\mathrm{GES}}$ | $\mathrm{V}_{\mathrm{GE}}=\mathrm{V}_{\mathrm{GES}}, \mathrm{V}_{\mathrm{CE}}=0 \mathrm{~V}$ | - | - | $\pm 400$ |

## ON CHARACTERISTICS

| G-E Threshold Voltage | $\mathrm{V}_{\mathrm{GE}(\mathrm{th})}$ | $\mathrm{I}_{\mathrm{C}}=40 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=\mathrm{V}_{\mathrm{GE}}$ | 3.5 | 5.5 | 7.5 | V |
| :--- | :---: | :--- | :---: | :---: | :---: | :---: |
| Collector to Emitter Saturation Voltage | $\mathrm{V}_{\mathrm{CE}(\text { sat })}$ | $\mathrm{I}_{\mathrm{C}}=40 \mathrm{~A}, \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}$ | - | 1.45 | 1.85 | V |
|  |  |  | $\mathrm{I}_{\mathrm{C}}=40 \mathrm{~A}, \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=175^{\circ} \mathrm{C}$ | - | 1.8 | - |

## FGH40T65SHDF

ELECTRICAL CHARACTERISTICS OF THE IGBT ( $T_{C}=25^{\circ} \mathrm{C}$ unless otherwise noted) (continued)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC CHARACTERISTICS |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {ies }}$ | $\mathrm{V}_{\mathrm{CE}}=30 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 1982 | - | pF |
| Output Capacitance | $\mathrm{C}_{\text {oes }}$ |  | - | 70 | - | pF |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {res }}$ |  | - | 25 | - | pF |

SWITCHING CHARACTERISTICS

| Turn-On Delay Time | $\mathrm{T}_{\mathrm{d}(\text { on) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=400 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=40 \mathrm{~A}, \\ & \mathrm{R}_{\mathrm{G}}=6 \Omega, \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}, \\ & \text { Inductive Load, } \mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C} \end{aligned}$ | - | 18 | - | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Rise Time | $\mathrm{T}_{\mathrm{r}}$ |  | - | 27 | - | ns |
| Turn-Off Delay Time | $\mathrm{T}_{\mathrm{d} \text { (off) }}$ |  | - | 64 | - | ns |
| Fall Time | $\mathrm{T}_{\mathrm{f}}$ |  | - | 3 | - | ns |
| Turn-On Switching Loss | $\mathrm{E}_{\text {on }}$ |  | - | 1.22 | - | mJ |
| Turn-Off Switching Loss | $\mathrm{E}_{\text {off }}$ |  | - | 0.44 | - | mJ |
| Total Switching Loss | $\mathrm{E}_{\text {ts }}$ |  | - | 1.66 | - | mJ |
| Turn-On Delay Time | $\mathrm{T}_{\mathrm{d} \text { (on) }}$ | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{CC}}=400 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=40 \mathrm{~A}, \\ & \mathrm{R}_{\mathrm{G}}=6 \Omega, \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}, \\ & \text { Inductive Load, } \mathrm{T}_{\mathrm{C}}=175^{\circ} \mathrm{C} \end{aligned}$ | - | 18 | - | ns |
| Rise Time | $\mathrm{T}_{\mathrm{r}}$ |  | - | 31 | - | ns |
| Turn-Off Delay Time | $\mathrm{T}_{\mathrm{d} \text { (off) }}$ |  | - | 70 | - | ns |
| Fall Time | $\mathrm{T}_{\mathrm{f}}$ |  | - | 56 | - | ns |
| Turn-On Switching Loss | $\mathrm{E}_{\text {on }}$ |  | - | 1.78 | - | mJ |
| Turn-Off Switching Loss | $\mathrm{E}_{\text {off }}$ |  | - | 0.78 | - | mJ |
| Total Switching Loss | $\mathrm{E}_{\text {ts }}$ |  | - | 2.56 | - | mJ |
| Total Gate Charge | $\mathrm{Q}_{\mathrm{g}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=400 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=40 \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V} \end{aligned}$ | - | 68 | - | nC |
| Gate to Emitter Charge | $\mathrm{Q}_{\mathrm{ge}}$ |  | - | 12 | - | nC |
| Gate to Collector Charge | $\mathrm{Q}_{\mathrm{gc}}$ |  | - | 25 | - | nC |

ELECTRICAL CHARACTERISTICS OF THE DIODE ( $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Test Conditions |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Diode Forward Voltage | $\mathrm{V}_{\mathrm{FM}}$ | $\mathrm{I}_{\mathrm{F}}=20 \mathrm{~A}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | - | 1.5 | 1.95 | V |
|  |  |  | $\mathrm{T}_{\mathrm{C}}=175^{\circ} \mathrm{C}$ | - | 1.37 | - |  |
| Reverse Recovery Energy | $\mathrm{E}_{\text {rec }}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=20 \mathrm{~A}, \\ & \mathrm{~d} \mathrm{I}_{\mathrm{F}} / \mathrm{dt}=200 \mathrm{~A} / \mathrm{s} \mathrm{~s} \end{aligned}$ | $\mathrm{T}_{\mathrm{C}}=175^{\circ} \mathrm{C}$ | - | 153 | - | $\mu \mathrm{J}$ |
| Diode Reverse Recovery Time | Trr |  | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | - | 101 | - | ns |
|  |  |  | $\mathrm{T}_{\mathrm{C}}=175^{\circ} \mathrm{C}$ | - | 238 | - |  |
| Diode Reverse Recovery Charge | $\mathrm{Q}_{\mathrm{rr}}$ |  | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | - | 343 | - | nC |
|  |  |  | $\mathrm{T}_{\mathrm{C}}=175^{\circ} \mathrm{C}$ | - | 1493 | - |  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.


Figure 1. Typical Output Characteristics


Figure 3. Typical Saturation Voltage Characteristics


Figure 5. Saturation Voltage vs $\mathrm{V}_{\mathrm{GE}}$


Figure 2. Typical Output Characteristics


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level


Figure 6. Saturation Voltage vs $\mathrm{V}_{\mathrm{GE}}$

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TYPICAL PERFORMANCE CHARACTERISTICS (continued)


Figure 7. Capacitance Characteristics


Figure 9. Turn-On Characteristics vs. Gate Resistance


Figure 11. Switching Loss vs. Gate Resistance


Figure 8. Gate Charge Characteristics


Figure 10. Turn-Off Characteristics vs. Gate Resistance


Figure 12. Turn-On Characteristics vs. Collector Current

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TYPICAL PERFORMANCE CHARACTERISTICS (continued)


Figure 13. Turn-Off Characteristics vs. Collector Current


Figure 15. Load Current vs. Frequency


Figure 17. Forward Characteristics


Figure 14. Switching Loss vs. Collector Current


Figure 16. SOA Characteristics


Figure 18. Reverse Recovery Current

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## TYPICAL PERFORMANCE CHARACTERISTICS (continued)



Figure 19. Reverse Recovery Time


Figure 20. Stored Charge


Figure 21. Transient Thermal Impedance of IGBT


Figure 22. Transient Thermal Impedance of Diode


NOTES: UNLESS OTHERWISE SPECIFIED.
A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD

FLASH, AND TIE BAR EXTRUSIONS.
B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5-2009.
D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC
MARKING DIAGRAM*


XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package
*This information is generic. Please refer to device data sheet for actual part marking $\mathrm{Pb}-$ Free indicator, " G " or microdot " r ", may or may not be present. Some products may not follow the Generic Marking.

DATE 09 OCT 2019


| DIM | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: |
|  | MIN | NOM | MAX |
| A | 4.58 | 4.70 | 4.82 |
| A1 | 2.29 | 2.475 | 2.66 |
| A2 | 1.40 | 1.50 | 1.60 |
| D | 20.32 | 20.57 | 20.82 |
| E | 15.37 | 15.62 | 15.87 |
| E2 | 4.96 | 5.08 | 5.20 |
| e | $\sim$ | 5.56 | $\sim$ |
| L | 19.75 | 20.00 | 20.25 |
| L1 | 3.69 | 3.81 | 3.93 |
| DP | 3.51 | 3.58 | 3.65 |
| Q | 5.34 | 5.46 | 5.58 |
| S | 5.34 | 5.46 | 5.58 |
| b | 1.17 | 1.26 | 1.35 |
| b2 | 1.53 | 1.65 | 1.77 |
| b4 | 2.42 | 2.54 | 2.66 |
| c | 0.51 | 0.61 | 0.71 |
| D1 | 13.08 | $\sim$ | $\sim$ |
| D2 | 0.51 | 0.93 | 1.35 |
| E1 | 12.81 | $\sim$ | $\sim$ |
| $\phi$ P1 | 6.61 | 6.73 | 6.85 |


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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | TO-247-3LD | PAGE 1 OF 1 |

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IXA40RG1200DHGLB APT70GR65B2DU40 NTE3320 IHFW40N65R5SXKSA1 APT70GR120J APT35GP120JDQ2
IKZA40N65RH5XKSA1 IKFW75N65ES5XKSA1 IKFW50N65ES5XKSA1 IKFW50N65EH5XKSA1 IKFW40N65ES5XKSA1 IKFW60N65ES5XKSA1 IMBG120R090M1HXTMA1 IMBG120R220M1HXTMA1 XD15H120CX1 XD25H120CX0 XP15PJS120CL1B1 IGW30N60H3FKSA1 STGWA8M120DF3 IGW08T120FKSA1 IGW75N60H3FKSA1 HGTG40N60B3 FGH60N60SMD_F085

FGH75T65UPD STGWA15H120F2 IKA10N60TXKSA1 IHW20N120R5XKSA1 RJH60D2DPP-M0\#T2 IKP20N60TXKSA1 IHW20N65R5XKSA1 IDW40E65D2FKSA1


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